#### Ratings

Type (inches)	Power Rating at 70 °C (W)	Limiting Element Voltage (Maximum RCWV) <sup>(1)</sup> (V)	Maximum Overload Voltage <sup>(2)</sup> (V)	Resistance Tolerance (%)	Resistance Range $^{\scriptscriptstyle (3)}$ ( $\Omega)$	T.C.R. [×10 <sup>-6</sup> /°C (ppm/°C)]	Category Temperature Range (Operating Temperature Range) (°C)
ERA3Y (0603)	0.1	75	150	±0.5 ±0.1	10         to         91         (E24)           100         to         33 k         (E24)           36 k         to         330 k         (E24)           100         to         33 k         (E24)	$\pm 50$ $\pm 25$ $\pm 100$ $\pm 25$	
ERA6Y (0805)	0.125	100	200	±0.5	10         to         91         (E24)           100         to         100 k         (E24)           110 k         to         1 M         (E24)           100         to         100 k         (E24)           100         to         100 k         (E24)		–55 to +125

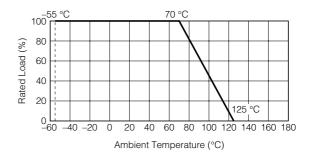
(1) Rated Continuous Working Voltage (RCWV) shall be determined from RCWV=VRated Power × Resistance Values, or Limiting Element Voltage (max. RCWV) listed above, whichever less.
(2) Overload (Short-time Overload) Test Voltage (SOTV) shall be determined from SOTV=2.5 × Power Rating or max. Overload Voltage listed above

whichever less.

(3) E96 series resistance values are also available. Please contact us for details. Part Number of E96 series is shown ERA3E. , ERA6E.

#### Power Derating Curve

For resistors operated in ambient temperatures above 70 °C, power rating shall be derated in accordance with the figure on the right.

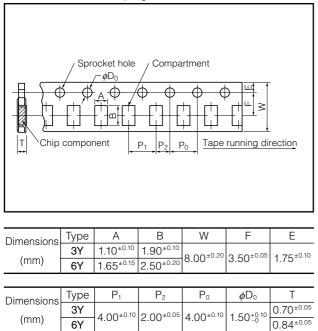


## Packaging Methods (Taping)

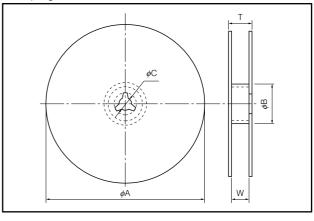
#### Standard Quantity

Туре	Kind of Taping	Pitch (P1)	Quantity	
ERA3Y	Dupphed Corrier Taping	4 mm		
ERA6Y	Punched Carrier Taping		5000 pcs./reel	

## • Punched Carrier Taping



Taping Reel



Dimensions	Туре	φA	φB	φC	
(mm)	3Y 6Y	180.0 <sup>+0</sup> -3.0	60 min.	13.0 <sup>±1.0</sup>	
Dimensions	Туре	W	Т		
(mm)	3Y 6Y	9.0 <sup>±1.0</sup>	11.4 <sup>±1.0</sup>	_	

Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use. Should a safety concern arise regarding this product, please be sure to contact us immediately.

Time

60 s to 120 s

30 s to 40 s

max. 10 s

Time

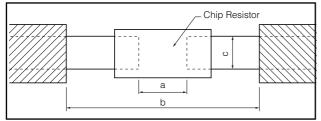
60 s to 120 s

30 s to 40 s

max. 10 s

## Recommended Land Pattern

In case of flow soldering, the land width must be smaller than the Chip Resistor width to properly control the solder amount properly. Generally, the land width should be 0.7 to 0.8 times (W) of the width of chip resistor. In case of reflow soldering, solder amount can be adjusted, therefore the land width should be set to 1.0 to 1.3 times chip resistor width (W).



Type (inches)	Dimensions (mm)			
(inches)	а	b	С	
ERA3Y (0603)	0.7 to 0.9	2 to 2.2	0.8 to 1	
ERA6Y (0805)	1 to 1.4	3.2 to 3.8	0.9 to 1.4	

Temperature

140 °C to 160 °C

Above 200 °C

235 ± 5 °C

Temperature

150 °C to 180 °C

Above 230 °C

max. 260 °C

For lead-free soldering (Example : Sn/Ag/Cu)

For soldering (Example : Sn/Pb)

Preheating

Preheating

Main heating

Peak

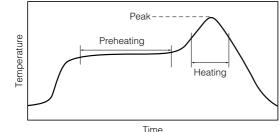
Peak

Main heating

### Recommended Soldering Conditions

Recommendations and precautions are described below.

- Recommended soldering conditions for reflow
- · Reflow soldering shall be performed a maximum of two times.
- Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



• Recommended soldering conditions for flow

	For so	Idering	For lead-free soldering		
	Temperature	Time	Temperature	Time	
Preheating	140 °C to 180 °C	60 s to 120 s	150 °C to 180 °C	60 s to 120 s	
Soldering	245 ± 5 °C	20 s to 30 s	max. 260 °C	max. 10 s	

# ▲ Safety Precautions

The following are precautions for individual products. Please also refer to the precautions common to Fixed Resistors shown on page ER2 of this catalog.

- 1. Keep the rated power and ambient temperature within the specified derating curve.
- \* When positioning and mounting Metal Film Chip Resistors (hereafter called the resistors), make allowance for the effect of heat generated through close contact between the resistors and neighboring components and for the temperature rise of adjacent heat-generating components.
- 2. If a transient load (heavy load in a short time) like a pulse is expected to be applied, check and evaluate the operations of the resistors when installed in your products before use.
  - When applying pulses to the resistors, keep the pulse peak within the rated voltage.
- 3. Do not use halogen-based or other high-activity flux. Otherwise, the residue may impair the resistors' performance and/or reliability.
- 4. When soldering with a soldering iron, never touch the resistors' bodies with the tip of the soldering iron. When using a soldering iron with a high temperature tip, finish soldering as quickly as possible (within three seconds at 350 °C max.).
- 5. As the amount of applied solder becomes larger, the mechanical stress applied to the resistors increases, causing problems such as cracks and faulty characteristics. Avoid applying an excessive amount of solder.
- 6. When the resistors' protective coatings are chipped, flawed, or removed, the characteristics of the resistors may be impaired. Take special care not to apply mechanical shock during automatic mounting or cause damage during handling of the boards with the resistors mounted.
- 7. Do not apply shock to the resistors or pinch them with a hard tool (e.g. pliers and tweezers). Otherwise, the resistors' protective coatings and bodies may be chipped, affecting their performance.
- 8. Avoid excessive bending of printed circuit boards in order to protect the resistors from abnormal stress.
- 9. Do not immerse the resistors in solvent for a long time. Before using solvent, carefully check the effects of immersion.